

ENGINEERING DEPT.

PRODUCT SPECIFICATION For CF29 Series Connector System

SPEC.NO.: SPCF052A

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1. SCOPE:

REVISIONS

This product specification contains the test method the general performance and requirement for CF29 series connectors.

2. APPLICABLE DOCUMENTS:

Reference documents listed below shall be the latest revision unless otherwise specified. Should a conflict occur between this specification and any of the listed documents then this specification shall prevail.

2.1 Industry standards :

EIA-364□□ electrical connector test procedures

- 3. SHAPE, CONSTRUCTION AND DIMENSIONS See attached drawings
- 4. MATERIALS See attached drawings
- 5. ACCOMMODATED P.C.BOARD
 5.1 Thickness: 0.5 mm (.020") ~ 2.0 mm (.079")
 5.2 P.C. Board Layout: See attached drawings
- 6. FPC/FFC RECOMMENDED SPECIFICATION:

Thickness : 0.3±0.03 mm (.012±.002") Gold Plated

Note : When using FFC/ FPC with Gold plated contact pads the connector contacts must be also plated.



REVIEWED : <u>Eisley</u> APPROVED : <u>Eisley</u> VERIFIED : <u>Sun</u>.



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7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage		0.5A DC max. 50V AC/DC max.
7.2	Contact Resistance	Measured at 20 mV maximum open circuit at 100mA .Mated test contacts must be in a connector housing. Test as per EIA364-23	Initially :Less than 40 m Ω Finally :Less than 80 m Ω
7.3	Dielectric strength	Test between adjacent contacts with a voltage of 500 VAC for 1 minute at Sea level. Test as per EIA364-20 Method B	No current leakage and flashover or damage detected.
7.4	Insulation Resistance	After 500 VDC for 1 minute, measure the insulation resistance between the adjacent contacts. Test as per EIA364-21	More than 500 MΩ

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT				
8.1	Contact retaining force in insulator	The end of terminal shall be pulled in a perpendicular to base housing at a maximum rate of 25 mm per minute. Test as per EIA 364-29	More than 0.15 Kgf				
8.2	FFC/FPC Retention Force	Apply axial load to FFC/FPC by operating at the speed rate of 25 mm per minute.	0.03Kgf/Pin min.				
8.3	Durability	Mate applicable FFC/FPC and insert and withdraw actuator at the speed rate of 25 mm per minute. Times :Up to 20 cycles.	Appearance: No damage Contact Resistance : Less than 80 mΩ FFC/FPC Ret. Force: 0.03 Kgf/Pin min.				
8.4	Fitting Nail Retention Force	Apply axial pull out of force at the speed of 25 mm per minute on the fitting nail assembled in the housing.	More than 0.15 Kgf				



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9. ENVIRONMENTAL PERFORMANCE:

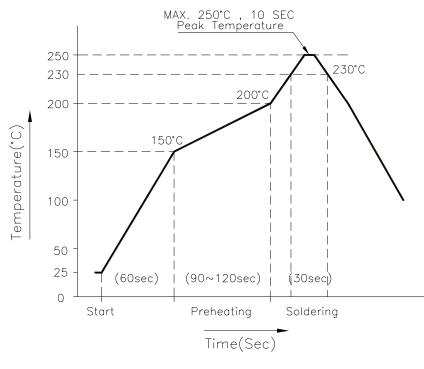
	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	The object of this test procedure is to detail a standard method to assess the current carrying capacity of mated battery connector contact. Test as per EIA364-70 Method B	0.5 A per pin minimum. The temperature rise above ambient shall not exceed 30° C at any point in the connector when contact positions are powered. The ambient condition is still air at 25° C.
9.2	Vibration	Subject mated FFC/FPC, All contacts shall be connected in series and DC 100mA shall be applied. Frequency:10~55 Hz Full amplitude1.5mm in 3 directions for 2 hours respectively. Test as per EIA 364 – 28 Condition I.	Appearance: No damage Discontinuity: 1 micro second max.
9.3	Physical Shock	Subject mated FFC/FPC to 50 g's half- sine shock pulses of 11ms duration. Three shocks in each direction applied along three mutually perpendicular planes for a total of 18 shocks. Test as per EIA364-27 condition A	Appearance: No damage Discontinuity: 1 micro second max.
9.4	Solderability	Steam age 1 hour at 90° C $\sim 96^{\circ}$ C Solder time to be 5±1 seconds at 245°C, using unactivated flux. Test as per EIA364-52	Minimum: 95% of immersed area
9.5	Resistance to soldering heat	Soldering time: 10 second Soldering pot: 250°C max. Reflow soldering (Infrared): Refer soldering method The conditions specified on the recommended temperature profile Shall be repeated twice.	No damage
9.6	Heat aging	Subject unmated connectors to temperature life at $85^{\circ}C\pm 2^{\circ}C$ for 96 hours. Test as per EIA 364-17 Test Condition III Method A.	Appearance : No damage Contact resistance : 40 mΩ change from initial.
9.7	Humidity	Subject unmated connectors to 96 hours at 40°C with 90% to 95% RH. Test as per EIA 364-31 Method Ⅱ Test Condition A.	Appearance : No damage Contact resistance and Insulation resistance shall meet requirement of 7.2,7.4



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	Ι	TEM	TEST CONDITION	REQUIREMENT						
9.8	Temperature cycling		Subject unmated connectors shall be tested in accordance with EIA364-32 Test Condition I. (1)-55°C,30 minute (2)+25°C,5 minute (3)+85°C,30 minute (4)+25°C,5 minute consecutive 10 cycles.	 Appearance: No damage Contact resistance : 40 mΩ change from initial. 						
9.9	Mixed Flowing Gas		There shall be no change in contact resistance greater than 40 m Ω from initial when mated specimens are subjected to environmental class II. Test as per EIA364-65 for 4 days mated. Relative Humidity : 70±2% Relative Temp. : 30±2°C Pollutant Concentration : Cl2 : 10±3 ppb NO2 : 200±50 ppb H2S : 10±5 ppb	Appearance: No damage Contact resistance : 40 mΩ change from initial.						

10.Operating temperature range : -40 $^\circ$ C to +85 $^\circ$ C; Storage temperature range : -40 $^\circ$ C to +85 $^\circ$ C

11.Recommended Temperature Profile(Lead-Free):





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12. TEST SEQUENCES IDENTIFICATION:

Test of description		А	В	С	D	Е	F	G	Н	Ι	J	K	L	М
1	Examination of Product		1,6	1,4	1,3	1,3	1,7	1,3	1,3	1,5	1,5	1,5	1,3	1,3
2	FFC/FPC Retention Force		5											
3	Durability		3											
4	Vibration			2										
5	Physical Shock			3										
6	Contact retaining force in insulator				2									
7	Fitting-nail Retention Force					2								
8	Contact Resistance		2,4				2,5			2,4	2,4	2,4		
9	Insulation Resistance						3,6							
10	Dielectric strength							2						
11	Contact Current Rating								2					
12	Humidity						4							
13	Temperature Cycling									3				
14	Heat aging										3			
15	Mixed Flowing Gas											3		
16	Solderability												2	
17	Resistance to soldering heat													2



